504400743 06/06/2017

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
NEEL SHAH	05/04/2017
MICHAEL NEVE DE MEVERGNIES	05/09/2017

RECEIVING PARTY DATA

Name:	Intel Corporation
Street Address:	2200 Mission College Boulevard
City:	Santa Clara
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15615480

CORRESPONDENCE DATA

Fax Number: (503)796-2900

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (503) 222-9981

Email: elawless@schwabe.com

Correspondent Name: SCHWABE, WILLIAMSON & WYATT, P.C. Address Line 1: 1211 SW FIFTH AVENUE, SUITE 1600

Address Line 4: PORTLAND, OREGON 97204

ATTORNEY DOCKET NUMBER:	116536-221944 (P111120)
NAME OF SUBMITTER:	ENOY LAWLESS
SIGNATURE:	/Enoy Lawless/
DATE SIGNED:	06/06/2017

Total Attachments: 4

source=P111120 Assignment#page1.tif source=P111120 Assignment#page2.tif source=P111120 Assignment#page3.tif source=P111120 Assignment#page4.tif

PATENT 504400743 REEL: 042620 FRAME: 0490

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

NEEL SHAH MICHAEL NEVE DE MEVERGNIES

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

SECURITY POLICY MANAGEMENT FOR A PLURALITY OF DIES IN A SYSTEM-ON-CHIP

(I hereby authorize and request any attorney	having appropriate authority from the assignce to insert on the
designated lines below, the filing date and app	olication number of said application when known.)

which was filed on	June 6, 2017	28	
United States	Application Numb	15/615 AOA	anc anc

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filled in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors,

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assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

neave	05/04/2017
NEEL SHAH	Date signed
MICHAEL NEVE DE MEVERGNIES	Date signed

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

NEEL SHAH MICHAEL NEVE DE MEVERGNIES

hereby sell, assign, and transfer to:

COUNTRY or International Office

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a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

SECURITY POLICY MANAGEMENT FOR A PLURALITY OF DIES IN A SYSTEM-ON-CHIP

designated lines below, the filing date and	application number of	said application when known.)	
which was filed onJune 6,	2017	as	
United States	Application Number	15/615,480	

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below.

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignce may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors,

Page 1 of 2

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assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof, and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

NEEL SHAH	Date signed	*****
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MICHAEL NEVE DE MEVERGNIES	Date signed	

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